

STU7LN80K5

N-channel 800 V, 0.95 Ω typ., 5 A MDmesh[™] K5 Power MOSFET in a IPAK package

Datasheet - production data

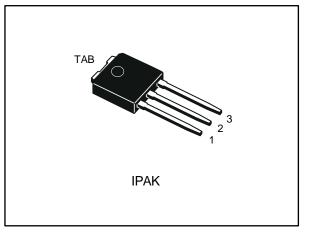
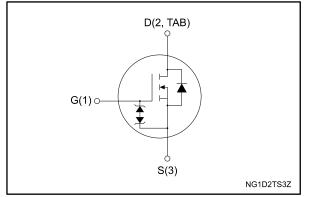


Figure 1: Internal schematic diagram



Features

Order code	code V _{DS} R _{DS(on)} max.		ID
STU7LN80K5	800 V	1.15 Ω	5 A

- Industry's lowest R_{DS(on)} x area
- Industry's best figure of merit (FoM)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh[™] K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STU7LN80K5	7LN80K5	IPAK	Tube

DocID028830 Rev 1

This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage	± 30	V
Ι _D	Drain current (continuous) at T _C = 25 °C	5	А
ID	Drain current (continuous) at $T_C = 100 \ ^\circ C$	3.4	А
ا _D ⁽¹⁾	Drain current (pulsed)	20	А
P _{TOT}	Total dissipation at $T_C = 25 \text{ °C}$	85	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	4.5	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature	55 to 150	°C
Tj	Operating junction temperature	- 55 to 150	C

Notes:

 $^{(1)}\mbox{Pulse}$ width limited by safe operating area.

 $^{(2)}I_{SD} \leq 5$ A, di/dt ≤ 100 A/µs; V_DS peak $\leq V_{(BR)DSS},$ V_DD = 400 V

⁽³⁾V_{DS} ≤ 640 V

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	1.47	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	100	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetetive or not repetetive (pulse width limited by $T_{jmax})$	1.5	A
E _{AS}	(Single pulse avalanche energy (starting T_j = 25 °C, I_D = $I_{AR};$ V_{DD} = 50 V)	200	mJ



2 Electrical characteristics

 $T_C = 25$ °C unless otherwise specified

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 V$, $I_D = 1 mA$	800			V
	Zara nata valtara Drain	$V_{GS} = 0 \text{ V}, \text{ V}_{DS} = 800 \text{ V}$			1	μA
Ince	Zero gate voltage Drain current	$V_{GS} = 0 V, V_{DS} = 800 V,$ $T_{C} = 125 °C$			50	μA
I _{GSS}	Gate-body leakage current	V_{DS} = 0 V, V_{GS} = ±20 V			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 100 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V_{GS} = 10 V, I _D = 2.5 A		0.95	1.15	Ω

Table 6: Dynamic						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	270	-	pF
Coss	Output capacitance	V_{DS} = 100 V, f = 1 MHz,	-	22	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	0.5	-	pF
C _{o(er)} ⁽¹⁾	Equivalent capacitance energy related	$V_{DS} = 0$ to 640 V, $V_{GS} = 0$ V	-	17	-	nC
C _{o(tr)} ⁽²⁾	Equivalent capacitance time related		-	48	-	nC
R _G	Intrinsic gate resistance	f = 1 MHz, open drain	-	7.5	-	Ω
Qg	Total gate charge	$V_{DD} = 640 \text{ V}, \text{ I}_{D} = 5 \text{ A},$	-	12	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 10 V (see Figure 15: "Test circuit for gate charge	-	2.6	-	nC
Q _{gd}	Gate-drain charge	behavior")	-	8.6	-	nC

Notes:

 $^{(1)}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

 $^{(2)}$ Time related is defined as a constant equivalent capacitance giving the same stored energy as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 7. Switching times							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t _{d(on)}	Turn-on delay time	V_{DD} = 400 V, I_D = 2.5 A, R_G = 4.7 Ω ,	-	9.3	-	ns	
tr	Rise time	V _{GS} = 10 V (see Figure 14: "Test circuit for resistive load switching	-	6.7	-	ns	
t _{d(off)}	Turn-off-delay time	times" and Figure 19: "Switching	-	23.6	-	ns	
t _f	Fall time	time waveform")	-	17.4	-	ns	



Electrical characteristics

Table 8: Source drain diode							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
I _{SD}	Source-drain current		-		5	А	
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		20	А	
V _{SD} ⁽²⁾	Forward on voltage	I_{SD} = 5 A, V_{GS} = 0 V	-		1.6	V	
t _{rr}	Reverse recovery time	$I_{SD} = 5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$ $V_{DD} = 60 \text{ V}$ (see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	276		ns	
Q _{rr}	Reverse recovery charge		-	2.13		μC	
I _{RRM}	Reverse recovery current		-	15.4		А	
t _{rr}	Reverse recovery time	I _{SD} = 5 A, di/dt = 100 A/µs,	-	402		ns	
Q _{rr}	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see Figure 16: "Test circuit for	-	2.79		μC	
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	13.9		А	

Notes:

 $^{(1)}\mbox{Pulse}$ width is limited by safe operating area

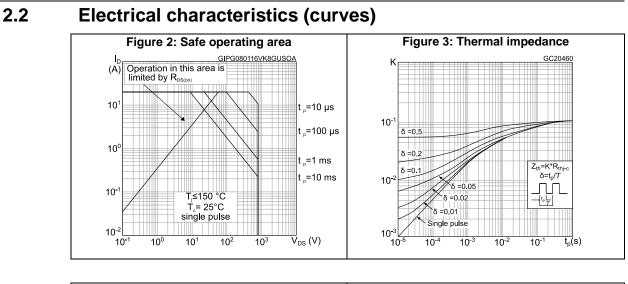
 $^{(2)}\text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%

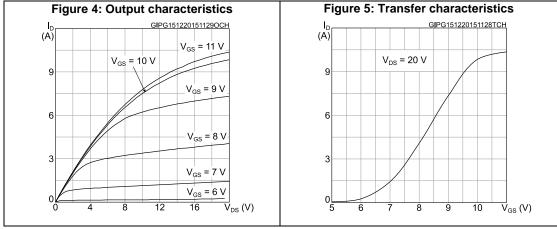
Table 9: Gate-source Zener diode

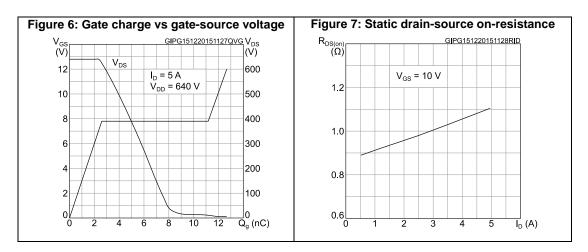
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)GSO}	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	30	-		V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.





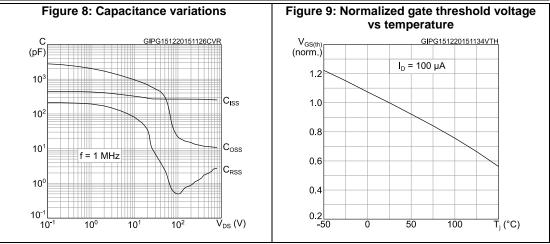


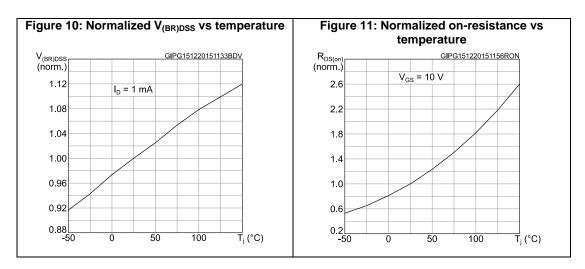


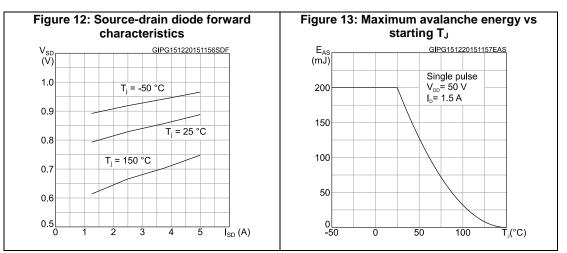


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Electrical characteristics



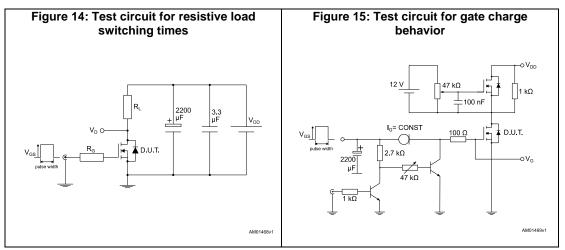


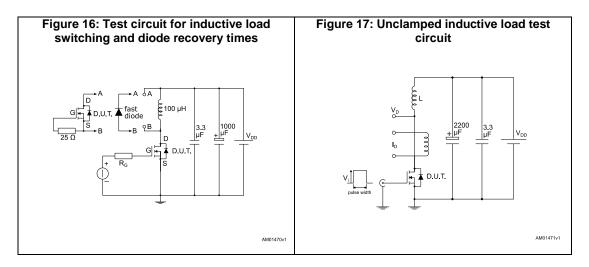


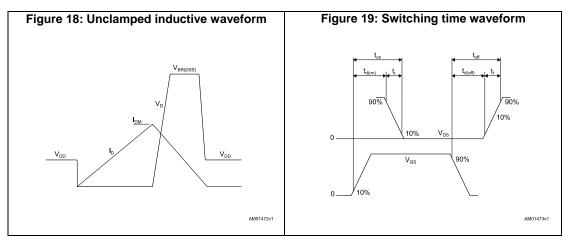


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3 Test circuits











4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 **IPAK type C package information**

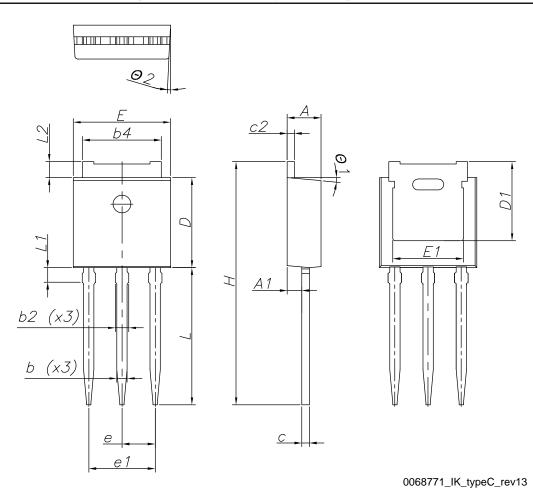


Figure 20: IPAK (TO-251) type C package outline



Package information

STU7LN80K5

formation STU7LN80K							
Ta	ble 10: IPAK (TO-251) typ	e C package mechanical	data				
Dim.	mm						
Dini.	Min.	Тур.	Max.				
A	2.20	2.30	2.35				
A1	0.90	1.00	1.10				
b	0.66		0.79				
b2			0.90				
b4	5.23	5.33	5.43				
С	0.46		0.59				
c2	0.46		0.59				
D	6.00	6.10	6.20				
D1	5.20	5.37	5.55				
E	6.50	6.60	6.70				
E1	4.60	4.78	4.95				
e	2.20	2.25	2.30				
e1	4.40	4.50	4.60				
Н	16.18	16.48	16.78				
L	9.00	9.30	9.60				
L1	0.90	1.00	1.20				
L2	0.90	1.08	1.25				
θ1	3°	5°	7°				
θ2	1°	3°	5°				



5 Revision history

Table 11: Document revision history

Date	Revision	Changes
08-Jan-2016	1	First release.



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